Angle -

the inventorship in this application needs to be changed by adding José Teixeira Pires. I spoke to Leland about this and he said to I spoke to Leland about this and the said to just leave you a note in the file and that you just leave you a note in the file and that you would change the inventorship

Per need more institution: address...

Address on new declarection



### RECEIVED TO 1700 IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

David SILAGY et al.

Serial No.:

10/051,291

Examiner: Not Yet Assigned

Filed:

January 22, 2002

Group Art Unit: 1772

For:

THERMOFORMING MULTILAYER FILM FOR PROTECTING

SUBSTRATES AND OBJECTS OBTAINED

STATEMENT OF ASSIGNEE UNDER 37 C.F.R. §1.48(a)

Commissioner for Patents Washington, DC 20231

Sir:

ATOFINA is the assignee of the above-identified application by virtue of an assignment from the originally named inventors (recorded April 17, 2002, Reel 012815/Frame 0041) and the attached copy of such assignment hereby consents to the requested change in inventorship to add JoséTEIXEIRA PIRES to the above-identified patent application. The undersigned has authority to sign on behalf of the assignee.

<u>September 9, 2003</u> Date:

Signed:

Henry

ATOCM-244



### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE SEP 19 2003

Ín re Application of:

David SILAGY et al.

Serial No.:

10/051,291

Examiner: Not Yet Assigned

Filed:

January 22, 2002

Group Art Unit: 1772

For:

THERMOFORMING MULTILAYER FILM FOR PROTECTING

SUBSTRATES AND OBJECTS OBTAINED

### STATEMENT OF NAMED INVENTOR UNDER 37 C.F.R. §1.48(a)

Commissioner for Patents Washington, DC 20231.

Sir:

The undersigned, a named inventor of the above-identified application, has no disagreement with the requested change in inventorship to add José TEIXEIRA PIRES to the above-identified patent application.

ATOCM-244



### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

SEP 29 MB

In re Application of:

David SILAGY et al.

Serial No.:

10/051,291

Examiner: Not Yet Assigned

Filed:

January 22, 2002

Group Art Unit: 1772

For:

THERMOFORMING MULTILAYER FILM FOR PROTECTING

SUBSTRATES AND OBJECTS OBTAINED

### STATEMENT OF NAMED INVENTOR UNDER 37 C.F.R. §1.48(a)

Commissioner for Patents Washington, DC 20231

Sir:

The undersigned, a named inventor of the above-identified application, has no disagreement with the requested change in inventorship to add José TEIXEIRA PIRES to the above-identified patent application.

ATOCM-244



# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE PECEIVEL SEPTION TO 1700

In re Application of:

David SILAGY et al.

Serial No.:

10/051,291

Examiner: Not Yet Assigned

Filed:

January 22, 2002

Group Art Unit: 1772

For:

THERMOFORMING MULTILAYER FILM FOR PROTECTING

SUBSTRATES AND OBJECTS OBTAINED

### STATEMENT OF NAMED INVENTOR UNDER 37 C.F.R. §1.48(a)

Commissioner for Patents Washington, DC 20231

Sir:

The undersigned, a named inventor of the above-identified application, has no disagreement with the requested change in inventorship to add José TEIXEIRA PIRES to the above-identified patent application.

Date: June 30/2 2003

David SILAGY

ATOCM-244



### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE TO 1700

In re Application of:

David SILAGY et al.

Serial No.:

10/051,291

Examiner: Not Yet Assigned

Filed:

January 22, 2002

Group Art Unit: 1772

For:

THERMOFORMING MULTILAYER FILM FOR PROTECTING

SUBSTRATES AND OBJECTS OBTAINED

### STATEMENT OF NAMED INVENTOR UNDER 37 C.F.R. §1.48(a)

Commissioner for Patents Washington, DC 20231

Sir:

The undersigned, a named inventor of the above-identified application, has no disagreement with the requested change in inventorship to add José TEIXEIRA PIRES to the above-identified patent application.

Date: August 6 2003

Franck BERTOUX

ATOCM-244



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE $\frac{RECE/VE}{SEP_{29}}$ $\frac{SEP_{29}}{TC}$ $\frac{1700}{1700}$

In re Application of:

David SILAGY et al.

Serial No.:

10/051,291

Examiner: Not Yet Assigned

Filed:

January 22, 2002

Group Art Unit: 1772

For:

THERMOFORMING MULTILAYER FILM FOR PROTECTING

SUBSTRATES AND OBJECTS OBTAINED

### STATEMENT OF UNINTENTIONALLY OMITTED INVENTOR

Commissioner for Patents Washington, DC 20231

Sir:

The undersigned inventor understands that he was unintentionally omitted with no deceptive intent on his part as one of the inventors for the above-identified application, and has no disagreement with the requested change in inventorship to be added to the above-identified patent application.

ATOCM-244